Seplife® Ramage Resin



1. Description

Seplife® Ramage Resin contains Ramage linker dibenzocycloheptadiene attached to aminomethylated resin beads. Following Fmoc removal, the resin can be acylated under standard conditions and used for solid phase peptide synthesis (SPPS). The linker is considerably more acid sensitive than Rink Amide, which enables peptide amides to be cleaved from the resin with 3% TFA allowing for the preparation of acid sensitive peptides or protected peptide fragments. Ramage resin is particularly recommended for C-terminal Phe, Tyr and Ile.

2. Properties

Product	Seplife® Ramage Resin	
Appearance	Pale off white or light yellow beads	
Туре	Gel type resin functionalized with Fmoc groups	
Matrix	1% DVB/polystyrene	
	0.3 -0.6	
Substitution (mmol/g)	0.6-0.8	
	0.8-1.0	
Particle size range (mesh/micron)	100-200 / 75-150	
Shipped as	Dry	

3.Storage

Seplife® Ramage Resin that is not for immediate use should be stored in dry form in a closed container at 2-8 °C.



Product Data Sheet

Seplife® Ramage Resin



4. Transportation

Avoid sunlight, rain, and heavy pressure during transportation. It is strictly forbidden to transport together with toxic and hazardous materials. Product can be shipped at ambient temperature.

5.Ordering information

Product Name	References	Substitution (mmol/g)
Seplife® Ramage Resin	LXSS14-1-1401	0.3-0.6
	LXSS14-1-1402	0.6-0.8
	LXSS14-1-1403	0.8-1.0

Production date: See label

Expiry date: 3 years, under proper storage conditions

Manufacturer: Sunresin New Materials Co. Ltd.

Add:No. 135, Jinye Rd, Xi'an Hi-

tech Industrial Development Zone, Shaanxi, 710076, China

www.seplite.com www.sunresin.com
E-mail: info.lifescience@sunresin.com

All information set forth herein is for informational purposes only. This information is general descriptive(introductory) information of SUNRESIN and its related products, technologies and services. Neither shall constitute the guarantee of SUNRESIN and its affiliates to products, technologies and services in specific fields and specific application conditions results, unless otherwise expressly noted. SUNRESIN and its affiliates assumes no obligation or liability for the information in this document. Customer is responsible for judging whether the information is appropriate for Customer's concrete demand and are obliged to understand whether the use of these products, technologies and services is permitted by the laws and regulations of their countries and relevant regions. Unless expressly stated, no freedom from infringement of use any patent or trademark or intellectual property rights owned by SUNRESIN or its affiliated companies under this document is to be inferred.

